



PATENTS
112055-0040P1
17732-38560.001

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re The Application of:)	
David Chong Sook Lim et al.)	
)	
Serial No.: 10/664,982)	Examiner: Leonardo Andujar
)	
Filed: September 17, 2003)	
)	Art Unit: 2826
For: PACKAGING SYSTEM FOR DIE-)	
UP CONNECTION OF A DIE-)	
DOWN ORIENTED INTEGRATED)	
CIRCUIT)	
		Cesari and McKenna, LLP
		88 Black Falcon Avenue
		Boston, MA 02210
		September 7, 2005

EXPRESS-MAIL DEPOSIT

"Express Mail" Mailing-Label Number: EV432397743US

The following papers are being deposited with the United States Postal Service
"Express Mail Post Office to Addressee" service pursuant to 37 C.F.R. §1.10:

<u>X</u> Check No. <u>31033</u> for \$120.00	<u>X</u> Petition 1 Months of Extended Time
<u>X</u> Return Receipt Postcard	<u>X</u> Response to Office Action